



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _A = +25°C		
	120mΩ @ V _{GS} = -4.5V			
-20V	150mΩ @ V _{GS} = -2.5V	-3A		

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

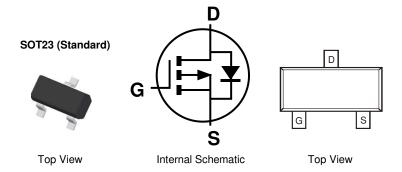
- Backlighting
- Power Management Functions
- DC-DC Converters
- Motor Control

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)



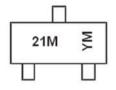
Ordering Information (Note 4)

Part Number	Case	Packaging
DMG2301L-7	SOT23 (Standard)	3,000/Tape & Reel
DMG2301L-13	SOT23 (Standard)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/support/packaging/diodes-packaging/support/support/suppo$

Marking Information



21M = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	В			J	K	L	М	N	0	Р	R	S
	•			•								
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified)

Characteristic		Symbol	Value	Units
Drain-Source Voltage		V_{DSS}	-20	V
Gate-Source Voltage		Vgss	±8	V
Continuous Drain Current (Note 5) V _{GS} = -4.5V	l _D	-3 -1	А	
Pulsed Drain Current (Note 6)		I _{DM}	-10	Α
Drain-Source Diode Forward Current (t < 5 sec)		Is	-0.75	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.5	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	$R_{\theta JA}$	83	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

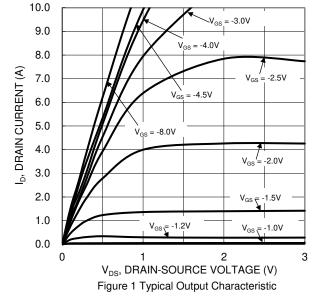
Electrical Characteristics (@TA = +25°C, unless otherwise specified)

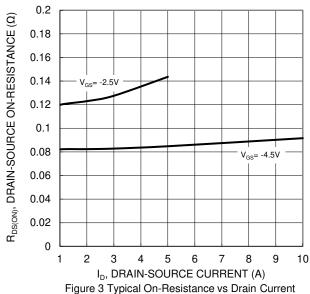
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	Oymbor		1,75	mux	Oint	rest condition
Drain-Source Breakdown Voltage	BVDSS	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	I _{DSS}	_	_	-1.0	μΑ	V _{DS} = -16V, V _{GS} = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 6V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-0.4	_	-1.2	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
Static Drain-Source On-Resistance	Dagger			120	mΩ	$V_{GS} = -4.5V$, $I_{D} = -2.8A$
Static Diani-Source On-Nesistance	RDS(ON)	_	_	150	11122	$V_{GS} = -2.5V$, $I_D = -2.0A$
Diode Forward Voltage	VsD	_		-1.2	V	$V_{GS} = 0V$, $I_{S} = -0.75A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		476	_	pF	\/ 10\/ \/ 0\/
Output Capacitance	Coss	_	53		pF	$V_{DS} = -10V, V_{GS} = 0V$ - $f = 1.0MHz$
Reverse Transfer Capacitance	C_{rss}	_	45		pF	1 – 1.000112
Total Gate Charge	Q_g	_	5.5		nC	
Gate-Source Charge	Q_{gs}	_	0.9	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -6V$, $I_{D} = -2.8A$
Gate-Drain Charge	Q_{gd}	_	1.8	_	nC	
Turn-On Delay Time	td(ON)	_	5	_	ns	
Turn-On Rise Time	tR	_	10	_	ns	$V_{DS} = -6V, V_{GS} = -4.5V,$
Turn-Off Delay Time	tD(OFF)	_	30		ns	$R_{GEN} = 6\Omega$, $I_D = -1A$
Turn-Off Fall Time	t _F	_	20	_	ns	

Notes:

- 5. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
- 6. Repetitive rating, pulse width limited by junction temperature.
- 7. Short duration pulse test used to minimize self-heating effect.
 8. Guaranteed by design. Not subject to production testing.







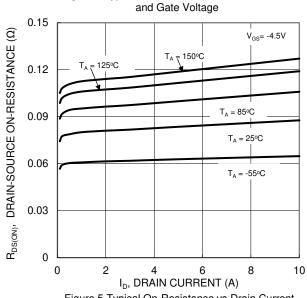
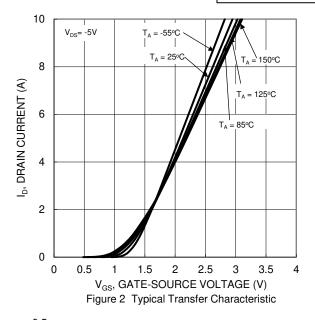
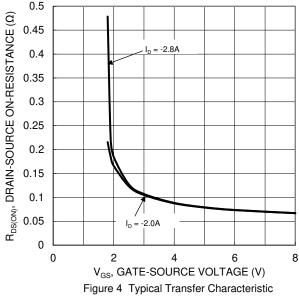


Figure 5 Typical On-Resistance vs Drain Current and Temperature





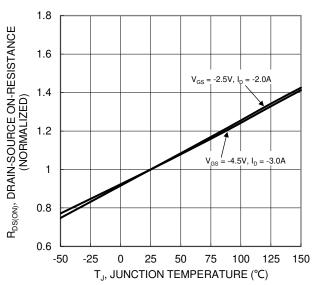


Figure 6 On-Resistance Variation with Temperature



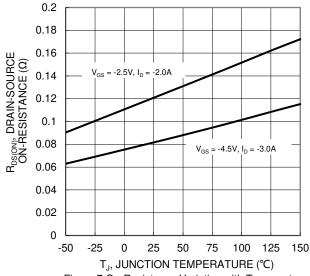


Figure 7 On-Resistance Variation with Temperature

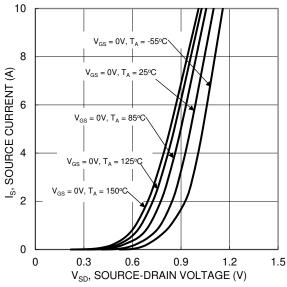
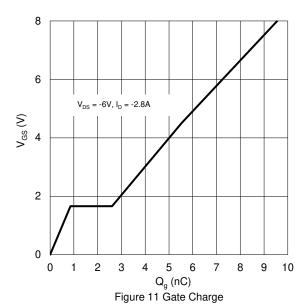


Figure 9 Diode Forward Voltage vs. Current



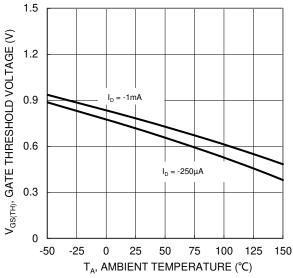
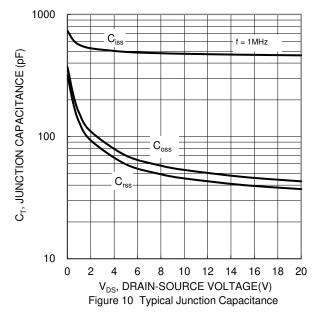


Figure 8 Gate Threshold Variation vs Ambient Temperature



100

R_{DS(ON)}
Limited

P_w=10s

P_w=10s

P_w=10ms

T_{A=25°C}
V_{OS}=4.5V
Single Pulse
DUT on 1*MRP
Board

0.01

1 1 10 100

V_{DS}, DRAIN-SOURCE VOLTAGE (V)
Figure 12 SOA, Safe Operation Area



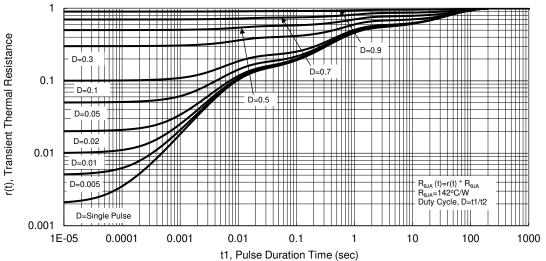


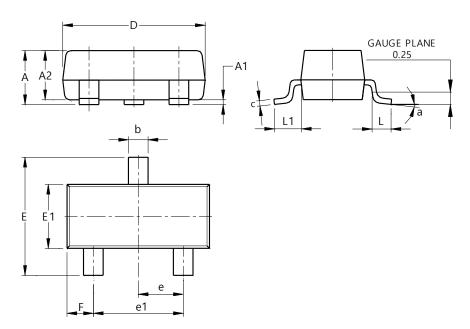
Figure 13 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23 (Standard)

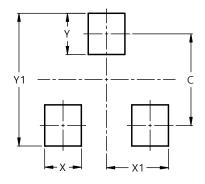


SOT23 (Standard)								
Dim	Min	Max	Тур					
Α	0.90	1.15	1.025					
A1	0.00	0.10	0.05					
A2	0.85	1.10	0.975					
b	0.30	0.51	0.40					
С	0.080	0.202	0.11					
D	2.80	3.00	2.90					
Е	2.25	2.55	2.40					
E1	1.20	1.40	1.30					
е	0.89	1.03	0.915					
e1	1.78	2.05	1.83					
F	0.40	0.60	0.535					
L1	0.45	0.61	0.55					
L	0.25	0.55	0.40					
а	0°	8°						
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23 (Standard)



Dimensions	Value (in mm)					
С	2.0					
Х	0.8					
X1	1.35					
Υ	0.9					
V1	29					



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